International **TOR** Rectifier

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	-55			V	$V_{GS} = 0V, I_D = -250 \mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		-0.034		V/°C	Reference to 25°C, I _D = -1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.065	Ω	V _{GS} = -10V, I _D = -16A ④
V _{GS(th)}	Gate Threshold Voltage	-2.0		-4.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
9 _{fs}	ForwardTransconductance	8.0			S	$V_{DS} = -25V, I_{D} = -16A$
I _{DSS}	Drain-to-Source Leakage Current			-25	μA	$V_{DS} = -55V, V_{GS} = 0V$
				-250		$V_{DS} = -44V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
1	Gate-to-Source Forward Leakage			100	nA	$V_{GS} = 20V$
I _{GSS}	Gate-to-Source Reverse Leakage			-100		V _{GS} = -20V
Qg	Total Gate Charge			63		I _D = -16A
Q _{gs}	Gate-to-Source Charge			13	nC	$V_{DS} = -44V$
Q _{gd}	Gate-to-Drain ("Miller") Charge			29		V_{GS} = -10V, See Fig. 6 and 13 \oplus 6
t _{d(on)}	Turn-On Delay Time		14			V _{DD} = -28V
tr	Rise Time		66			I _D = -16A
t _{d(off)}	Turn-Off Delay Time		39		ns	$R_G = 6.8\Omega$
t _f	Fall Time		63			R _D = 1.6Ω, See Fig. 10 ⊕€
L _D	Internal Drain Inductance		4.5		nH	Between lead,
						6mm (0.25in.)
L _S	Internal Source Inductance		7.5			from package
						and center of die contact S
C _{iss}	Input Capacitance		1200			$V_{GS} = 0V$
C _{oss}	OutputCapacitance		520		pF	V _{DS} = -25V
C _{rss}	Reverse Transfer Capacitance		250			f = 1.0MHz, See Fig. 5 ©

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			-31	Α	MOSFET symbol
	(Body Diode)					showing the
I _{SM}	Pulsed Source Current		110		integral reverse	
	(Body Diode) ①			-110		p-n junction diode.
V _{SD}	Diode Forward Voltage			-1.3	V	$T_J = 25^{\circ}C, I_S = -16A, V_{GS} = 0V$ (4)
t _{rr}	Reverse Recovery Time		71	110	ns	$T_J = 25^{\circ}C, I_F = -16A$
Q _{rr}	ReverseRecoveryCharge		170	250	nC	di/dt = -100A/µs ⊕ ©

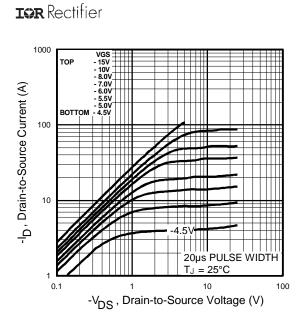
Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See Fig. 11)
- ④ Pulse width \leq 300µs; duty cycle \leq 2%.
- O V_{DD} = -25V, starting T_J = 25°C, L = 2.1mH $R_G = 25\Omega$, $I_{AS} = -16A$. (See Figure 12)
- ⑤ This is applied for I-PAK, L_S of D-PAK is measured between lead and center of die contact.
- © Uses IRF5305 data and test conditions.
- $\label{eq:ISD} \textcircled{3} I_{SD} \leq \textbf{-16A}, \, di/dt \leq \textbf{-280A}/\mu s, \, V_{DD} \leq V_{(BR)DSS}, \\$ $T_J\!\le\!175^\circ C$

* When mounted on 1" square PCB (FR-4 or G-10 Material).

For recommended footprint and soldering techniques refer to application note #AN-994.

** Uses typical socket mount.



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Fig 1. Typical Output Characteristics

IRFR/U5305PbF

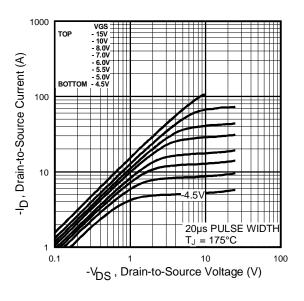


Fig 2. Typical Output Characteristics

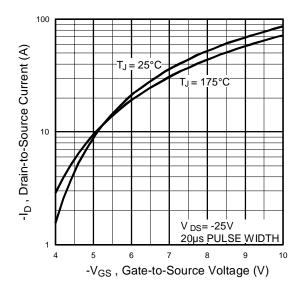


Fig 3. Typical Transfer Characteristics

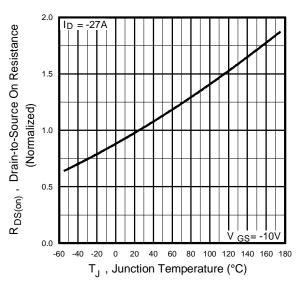
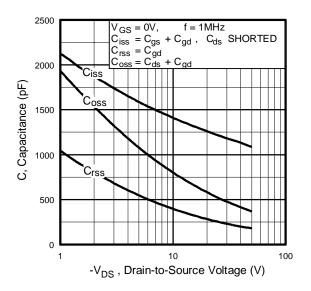


Fig 4. Normalized On-Resistance Vs. Temperature

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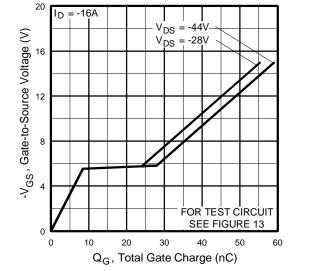
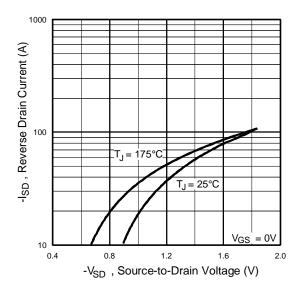
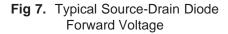


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage





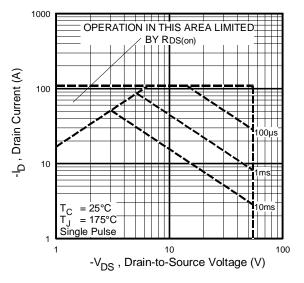
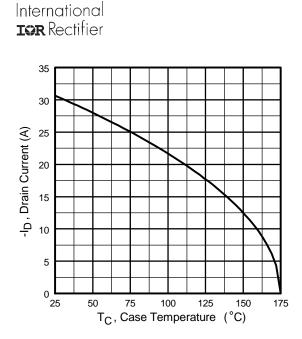
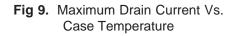
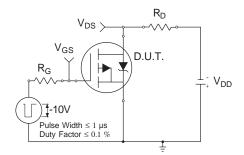
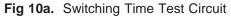


Fig 8. Maximum Safe Operating Area









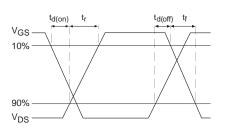


Fig 10b. Switching Time Waveforms

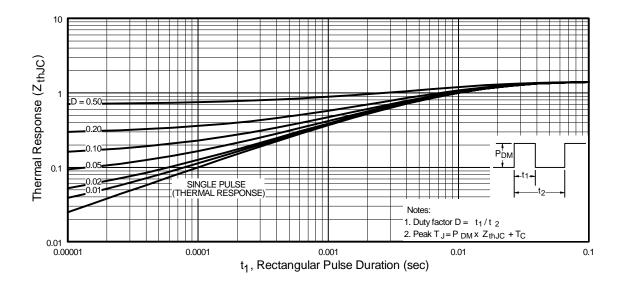


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

International **ISR** Rectifier

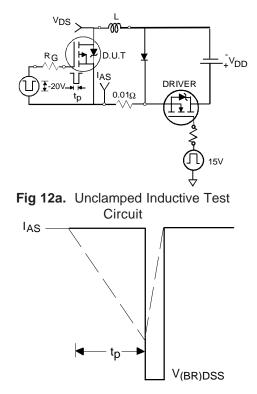


Fig 12b. Unclamped Inductive Waveforms

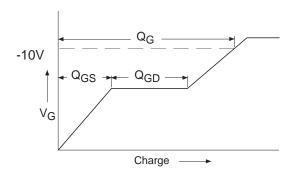
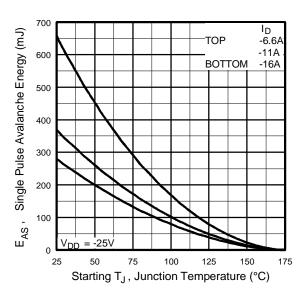
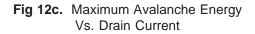


Fig 13a. Basic Gate Charge Waveform





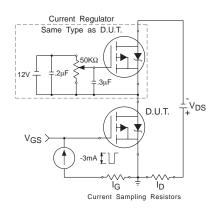
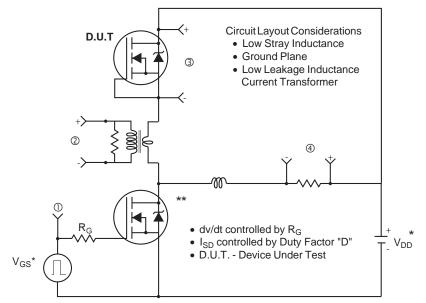


Fig 13b. Gate Charge Test Circuit

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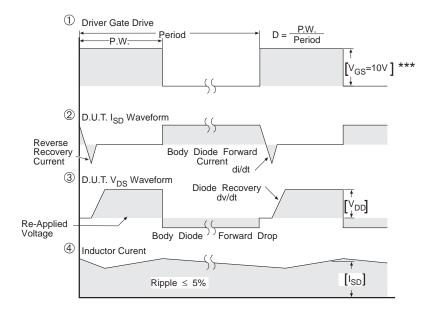
IRFR/U5305PbF

Peak Diode Recovery dv/dt Test Circuit



* Reverse Polarity for P-Channel

** Use P-Channel Driver for P-Channel Measurements



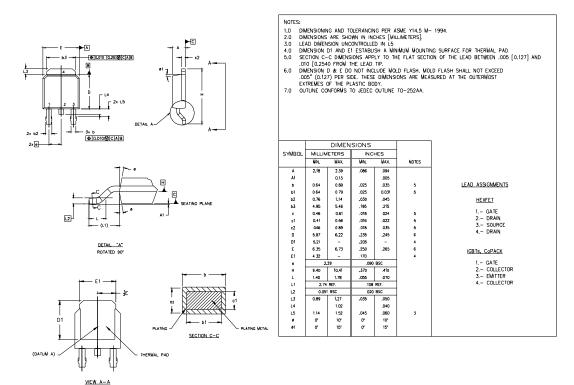
*** V_{GS} = 5.0V for Logic Level and 3V Drive Devices

Fig 14. For P-Channel HEXFETS

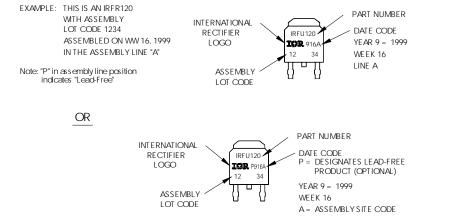
International **ISR** Rectifier

D-Pak (TO-252AA) Package Outline

Dimensions are shown in millimeters (inches)



D-Pak (TO-252AA) Part Marking Information

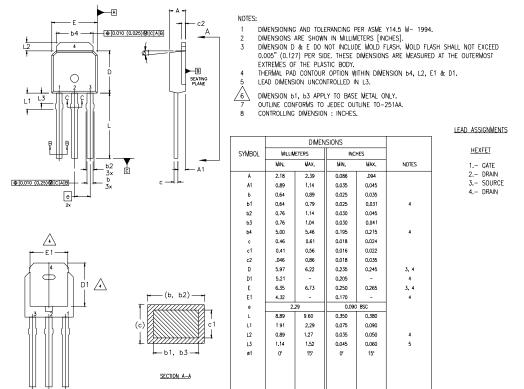


International **TOR** Rectifier

IRFR/U5305PbF

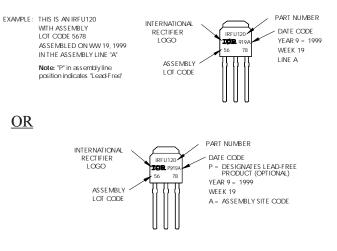
I-Pak (TO-251AA) Package Outline

Dimensions are shown in millimeters (inches)



VIEW A-A

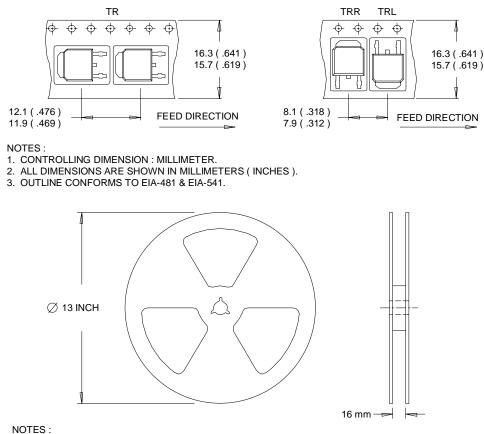
I-Pak (TO-251AA) Part Marking Information



International **ISPR** Rectifier

D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



1. OUTLINE CONFORMS TO EIA-481.

Data and specifications subject to change without notice.

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